AN79Lxx/AN79LxxM Series

3-pin negative output voltage regulator (100 mA type)

Overview

The AN79Lxx series and the AN79LxxM series are 3-pin, fixed negative output type monolithic voltage regulators.

Stabilized fixed output voltage is obtained from unstable DC input voltage without using any external components. 12 types of output voltage are available: -4V, -5V, -6V, -7V, -8V, -9V, -10V, -12V, -15V, -18V, -20Vand -24V. They can be used widely in power circuits with current capacity of up to 100mA.

Features

- No external components
- Output voltage: -4V, -5V, -6V, -7V, -8V, -9V, -10V, -12V, -15V, -18V, -20V, -24V
- Built-in overcurrent limit circuit
- Built-in thermal overload protection circuit



Note) The packages (SSIP003-P-0000 and HSIP003-P-0000B) of this product will be changed to lead-free type (SSIP003-P-0000S and HSIP003-P-0000Q). See the new package dimensions section later of this datasheet.

■ Block Diagram (AN79Lxx series)



Absolute Maximum Ratings at $T_a = 25^{\circ}C$

Parameter		Symbol	Rating	Unit	
Tamut volto co		V	-35 *1	V	
input voltage		V I	-40 *2	V	
Power dissipation		PD	650 *3	mW	
Operating ambient temperature		T _{opr}	-20 to +80	°C	
Champion to many terms	AN79Lxx series	T	-55 to +150	00	
Storage temperature	AN79LxxM series	I stg	-55 to +125		

*1 AN79L04, AN79L05/M, AN79L06, AN79L07/M, AN79L08/M, AN79L09/M, AN79L10/M, AN79L12/M, AN79L15/M, AN79L18

*2 AN79L20, AN79L24

*3 Follow the derating curve. When T_j exceeds 150°C, the internal circuit cuts off the output. AN79LxxM series is mounted on a standard board (glass epoxy: 20mm × 20mm × t1.7mm with Cu foil of 1cm² or more).

■ Electrical Characteristics at T_a = 25°C

• AN79L04 (-4V type)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Output voltage	Vo	$T_j = 25^{\circ}C$	-3.84	-4	-4.16	V
Output voltage tolerance	Vo	$V_{I} = -7$ to $-19V$, $I_{O} = 1$ to $70mA$	-3.8		-4.2	v
Line regulation	PEG	$V_{I} = -6$ to $-20V$, $T_{j} = 25^{\circ}C$	_		80	mV
Life regulation	KEOIN	$V_{I} = -7$ to $-17V$, $T_{j} = 25^{\circ}C$	_		40	mV
Load manufaction	DEC	$I_0 = 1$ to 100mA, $T_j = 25^{\circ}C$		10	60	mV
Load regulation	KEGL	$I_0 = 1 \text{ to } 40 \text{mA}, T_j = 25^{\circ}\text{C}$		4.5	30	mV
Bias current	I _{Bias}	$T_j = 25^{\circ}C$		3	5	mA
Bias current fluctuation to input	$\Delta I_{Bias(IN)}$	$V_{I} = -7$ to $-19V$, $T_{j} = 25^{\circ}C$			0.5	mA
Bias current fluctuation to load	$\Delta I_{Bias(L)}$	$I_0 = 1 \text{ to } 40 \text{mA}, T_j = 25^{\circ}\text{C}$	_		0.1	mA
Output noise voltage	V _{no}	$f = 10Hz$ to 100kHz, $T_a = 25^{\circ}C$		38		μV
Ripple rejection ratio	RR	$V_{I} = -7$ to $-17V$, f = 120Hz, $T_{a} = 25^{\circ}C$	55			dB
Minimum input/output voltage difference	V _{DIF(min)}	$T_j = 25^{\circ}C$		0.8		V
Output short-circuit current	I _{O(Short)}	$V_I = -35V, T_j = 25^{\circ}C$		200		mA
Output voltage temperature coefficient	$\Delta V_0/T_a$	$I_0 = 5mA$		- 0.4		mV/°C

Note 1) The specified condition $T_j = 25^{\circ}C$ means that the test should be carried out within so short a test time (within 10ms) that the characteristic value drift due to the chip junction temperature rise can be ignored.

Note 2) Unless otherwise specified, $V_I = -9V$, $I_O = 40mA$, $C_I = 2\mu F$, $C_O = 1\mu F$, $T_j = 0$ to $125^{\circ}C$

• AN79L05, AN79L05M (-5V type)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Output voltage	Vo	$T_j = 25^{\circ}C$	-4.8	-5	-5.2	v
Output voltage tolerance	Vo	$V_{I} = -8$ to $-20V$, $I_{O} = 1$ to $70mA$	-4.75		-5.25	V
Line regulation	DEC	$V_I = -7 \text{ to } -21 \text{V}, \ T_j = 25^{\circ} \text{C}$			100	mV
Line regulation	KEOIN	$V_{I} = -8 \text{ to } -18 \text{V}, \text{T}_{j} = 25^{\circ} \text{C}$			50	mV
Landmanulation	DEC	$I_0 = 1$ to 100mA, $T_j = 25^{\circ}C$		11	60	mV
Load regulation	KEGL	$I_0 = 1$ to 40mA, $T_j = 25^{\circ}C$		5	30	mV
Bias current	I _{Bias}	$T_j = 25^{\circ}C$		3	5	mA
Bias current fluctuation to input	$\Delta I_{Bias(IN)}$	$V_{I} = -8$ to $-20V$, $T_{j} = 25^{\circ}C$			0.5	mA
Bias current fluctuation to load	$\Delta I_{Bias(L)}$	$I_0 = 1 \text{ to } 40 \text{mA}, T_j = 25^{\circ}\text{C}$			0.1	mA
Output noise voltage	V _{no}	$f = 10Hz$ to $100kHz$, $T_a = 25^{\circ}C$		40		μν
Ripple rejection ratio	RR	$V_{I} = -8$ to $-18V$, $f = 120Hz$, $T_{a} = 25^{\circ}C$	55			dB
Minimum input/output voltage difference	V _{DIF(min)}	$T_j = 25^{\circ}C$		0.8		V
Output short-circuit current	I _{O(Short)}	$V_I = -35V, T_j = 25^{\circ}C$		200		mA
Output voltage temperature coefficient	$\Delta V_0/T_a$	$I_0 = 5mA$		- 0.4		mV/°C

Note 1) The specified condition $T_j = 25^{\circ}C$ means that the test should be carried out within so short a test time (within 10ms) that the characteristic value drift due to the chip junction temperature rise can be ignored.

Note 2) Unless otherwise specified, $V_I = -10V$, $I_O = 40$ mA, $C_I = 2\mu$ F, $C_O = 1\mu$ F, $T_j = 0$ to 125° C (AN79L05) and $T_j = 0$ to 100° C (AN79L05M)

• AN79L06 (-6V type)

Parameter	Symbol	Conditions	Min	Тур	Мах	Unit
Output voltage	Vo	$T_j = 25^{\circ}C$	-5.76	-6	-6.24	V
Output voltage tolerance	Vo	$V_{I} = -9$ to $-21V$, $I_{O} = 1$ to $70mA$	-5.7		-6.3	V
	PEG	$V_{I} = -8$ to $-22V$, $T_{j} = 25^{\circ}C$			120	mV
	KLOIN	$V_{I} = -9$ to $-19V$, $T_{j} = 25^{\circ}C$	_		60	mV
L and regulation	DEC	$I_0 = 1$ to 100mA, $T_j = 25^{\circ}C$		12	60	mV
Load regulation	KEGL	$I_0 = 1 \text{ to } 40 \text{mA}, T_j = 25^{\circ}\text{C}$		5.5	30	mV
Bias current	I _{Bias}	$T_j = 25^{\circ}C$	_	3	5	mA
Bias current fluctuation to input	$\Delta I_{Bias(IN)}$	$V_1 = -9$ to $-21V$, $T_j = 25^{\circ}C$	_		0.5	mA
Bias current fluctuation to load	$\Delta I_{Bias(L)}$	$I_0 = 1 \text{ to } 40 \text{mA}, T_j = 25^{\circ}\text{C}$			0.1	mA
Output noise voltage	V _{no}	$f = 10Hz$ to $100kHz$, $T_a = 25^{\circ}C$		44		μν
Ripple rejection ratio	RR	$V_1 = -9$ to $-19V$, f = 120Hz, $T_a = 25^{\circ}C$	55			dB
Minimum input/output voltage difference	V _{DIF(min)}	$T_j = 25^{\circ}C$		0.8		v
Output short-circuit current	I _{O(Short)}	$V_{I} = -35V, T_{j} = 25^{\circ}C$		200		mA
Output voltage temperature coefficient	$\Delta V_0/T_a$	$I_0 = 5mA$		- 0.4		mV/°C

Note 1) The specified condition $T_j = 25^{\circ}C$ means that the test should be carried out within so short a test time (within 10ms) that the characteristic value drift due to the chip junction temperature rise can be ignored.

Note 2) Unless otherwise specified, $V_1 = -11V$, $I_0 = 40mA$, $C_1 = 2\mu F$, $C_0 = 1\mu F$, $T_j = 0$ to $125^{\circ}C$

Electrical Characteristics at $T_a = 25^{\circ}C$ (continued)

• AN79L07, AN79L07M (-7V type)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Output voltage	Vo	$T_j = 25^{\circ}C$	-6.72	-7	-7.28	V
Output voltage tolerance	Vo	$V_{I} = -10$ to $-22V$, $I_{O} = 1$ to $70mA$	-6.65		-7.35	V
Line monlation	DEC	$V_{I} = -9$ to $-23V$, $T_{j} = 25^{\circ}C$			140	mV
Line regulation	KEOIN	$V_I = -10$ to $-20V$, $T_j = 25^{\circ}C$			70	mV
L and regulation	DEC	$I_0 = 1$ to 100mA, $T_j = 25^{\circ}C$		13	70	mV
Load regulation	REGL	$I_0 = 1$ to 40mA, $T_j = 25^{\circ}C$		6	40	mV
Bias current	I _{Bias}	$T_j = 25^{\circ}C$	_	3	5	mA
Bias current fluctuation to input	$\Delta I_{Bias(IN)}$	$V_I = -10$ to $-22V$, $T_j = 25^{\circ}C$	_		0.5	mA
Bias current fluctuation to load	$\Delta I_{Bias(L)}$	$I_0 = 1$ to 40mA, $T_j = 25^{\circ}C$			0.1	mA
Output noise voltage	V _{no}	$f = 10Hz$ to 100kHz, $T_a = 25^{\circ}C$	_	48		μν
Ripple rejection ratio	RR	$V_{I} = -10$ to $-20V$, $f = 120Hz$, $T_{a} = 25^{\circ}C$	54			dB
Minimum input/output voltage difference	V _{DIF(min)}	$T_j = 25^{\circ}C$		0.8		V
Output short-circuit current	$I_{O(Short)}$	$V_I = -35V, T_j = 25^{\circ}C$		200		mA
Output voltage temperature coefficient	$\Delta V_0/T_a$	$I_0 = 5mA$		- 0.5		mV/°C

Note 1) The specified condition $T_j = 25^{\circ}C$ means that the test should be carried out within so short a test time (within 10ms) that the characteristic value drift due to the chip junction temperature rise can be ignored.

Note 2) Unless otherwise specified, $V_I = -12V$, $I_0 = 40$ mA, $C_I = 2\mu$ F, $C_0 = 1\mu$ F, $T_j = 0$ to 125° C (AN79L07) and $T_j = 0$ to 100° C (AN79L07M)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Output voltage	Vo	$T_j = 25^{\circ}C$	-7.68	-8	-8.32	V
Output voltage tolerance	Vo	$V_I = -11$ to $-23V$, $I_O = 1$ to $70mA$	-7.6		-8.4	V
Line regulation	DEC	$V_I = -10$ to $-24V$, $T_j = 25^{\circ}C$			160	mV
Life regulation	KEOIN	$V_I = -11$ to $-21V$, $T_j = 25^{\circ}C$			80	mV
T and menulation	DEC	$I_0 = 1$ to 100mA, $T_j = 25^{\circ}C$		15	80	mV
Load regulation	KEUL	$I_0 = 1$ to 40mA, $T_j = 25^{\circ}C$		7	40	mV
Bias current	I _{Bias}	$T_j = 25^{\circ}C$		3	5	mA
Bias current fluctuation to input	$\Delta I_{Bias(IN)}$	$V_{I} = -11$ to $-23V$, $T_{j} = 25^{\circ}C$			0.5	mA
Bias current fluctuation to load	$\Delta I_{Bias(L)}$	$I_0 = 1$ to 40mA, $T_j = 25^{\circ}C$			0.1	mA
Output noise voltage	V_{no}	$f = 10Hz$ to 100kHz, $T_a = 25^{\circ}C$		52		μV
Ripple rejection ratio	RR	$V_{I} = -11$ to $-21V$, $f = 120Hz$, $T_{a} = 25^{\circ}C$	54			dB
Minimum input/output voltage difference	V _{DIF(min)}	$T_j = 25^{\circ}C$		0.8		V
Output short-circuit current	I _{O(Short)}	$V_I = -35V, T_j = 25^{\circ}C$		200		mA
Output voltage temperature coefficient	$\Delta V_0/T_a$	$I_0 = 5mA, T_j = 0 \text{ to } 125^{\circ}C$		- 0.6		mV/°C

AN79L08, AN79L08M (-8V type)

Note 1) The specified condition $T_j = 25^{\circ}C$ means that the test should be carried out within so short a test time (within 10ms) that the characteristic value drift due to the chip junction temperature rise can be ignored.

Note 2) Unless otherwise specified, $V_I = -14V$, $I_0 = 40$ mA, $\tilde{C}_I = 2\mu$ F, $C_0 = 1\mu$ F, $\tilde{T}_j = 0$ to 125°C (AN79L08) and $T_j = 0$ to 100°C (AN79L08M)

• AN79L09, AN79L09M (-9V type)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Output voltage	Vo	$T_j = 25^{\circ}C$	-8.64	-9	-9.36	V
Output voltage tolerance	Vo	$V_{I} = -12$ to $-24V$, $I_{O} = 1$ to $70mA$	-8.55		-9.45	V
Line regulation	PEG	$V_I = -11$ to $-25V$, $T_j = 25^{\circ}C$	_		160	mV
Line regulation	KEOIN	$V_{I} = -12$ to $-22V$, $T_{j} = 25^{\circ}C$			80	mV
Landmanulation	DEC	$I_0 = 1$ to 100mA, $T_j = 25^{\circ}C$		16	90	mV
Load regulation	KEGL	$I_0 = 1$ to 40mA, $T_j = 25^{\circ}C$		8	50	mV
Bias current	I _{Bias}	$T_j = 25^{\circ}C$		3	5	mA
Bias current fluctuation to input	$\Delta I_{Bias(IN)}$	$V_{I} = -12$ to $-24V$, $T_{j} = 25^{\circ}C$	_		0.5	mA
Bias current fluctuation to load	$\Delta I_{Bias(L)}$	$I_0 = 1 \text{ to } 40 \text{mA}, T_j = 25^{\circ}\text{C}$	_		0.1	mA
Output noise voltage	V _{no}	$f = 10Hz$ to 100kHz, $T_a = 25^{\circ}C$		58		μν
Ripple rejection ratio	RR	$V_{I} = -12$ to $-22V$, $f = 120Hz$, $T_{a} = 25^{\circ}C$	53			dB
Minimum input/output voltage difference	V _{DIF(min)}	$T_j = 25^{\circ}C$		0.8		V
Output short-circuit current	I _{O(Short)}	$V_I = -35V, T_j = 25^{\circ}C$		200		mA
Output voltage temperature coefficient	$\Delta V_0/T_a$	$I_0 = 5mA, T_j = 0 \text{ to } 125^{\circ}C$		- 0.6		mV/°C

Note 1) The specified condition $T_j = 25^{\circ}C$ means that the test should be carried out within so short a test time (within 10ms) that the characteristic value drift due to the chip junction temperature rise can be ignored.

Note 2) Unless otherwise specified, $V_I = -15V$, $I_0 = 40$ mA, $C_I = 2\mu$ F, $C_0 = 1\mu$ F, $T_j = 0$ to 125° C (AN79L09) and $T_j = 0$ to 100° C (AN79L09M)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Output voltage	Vo	$T_j = 25^{\circ}C$	-9.6	-10	-10.4	V
Output voltage tolerance	Vo	$V_I = -13$ to $-25V$, $I_O = 1$ to $70mA$	-9.5		-10.5	V
Line regulation	DEC	$V_I = -12$ to $-26V$, $T_j = 25^{\circ}C$			160	mV
Line regulation	KEOIN	$V_I = -13$ to $-23V$, $T_j = 25^{\circ}C$			80	mV
Load regulation	DEC	$I_0 = 1$ to 100mA, $T_j = 25^{\circ}C$		17	100	mV
Load regulation	KEUL	$I_0 = 1$ to 40mA, $T_j = 25^{\circ}C$		9	50	mV
Bias current	I _{Bias}	$T_j = 25^{\circ}C$		3	5	mA
Bias current fluctuation to input	$\Delta I_{Bias(IN)}$	$V_{I} = -13$ to $-25V$, $T_{j} = 25^{\circ}C$			0.5	mA
Bias current fluctuation to load	$\Delta I_{Bias(L)}$	$I_0 = 1$ to 40mA, $T_j = 25^{\circ}C$			0.1	mA
Output noise voltage	V _{no}	$f = 10Hz$ to 100kHz, $T_a = 25^{\circ}C$		65		μV
Ripple rejection ratio	RR	$V_{I} = -13$ to $-23V$, $f = 120Hz$, $T_{a} = 25^{\circ}C$	53			dB
Minimum input/output voltage difference	V _{DIF(min)}	$T_j = 25^{\circ}C$		0.8		V
Output short-circuit current	I _{O(Short)}	$V_I = -35V, T_j = 25^{\circ}C$		200		mA
Output voltage temperature coefficient	$\Delta V_0/T_a$	$I_0 = 5mA$		- 0.7		mV/°C

AN79L10, AN79L10M (-10V type)

Note 1) The specified condition $T_j = 25^{\circ}C$ means that the test should be carried out within so short a test time (within 10ms) that the characteristic value drift due to the chip junction temperature rise can be ignored.

Note 2) Unless otherwise specified, $V_I = -16V$, $I_0 = 40$ mA, $\tilde{C}_I = 2\mu$ F, $C_0 = 1\mu$ F, $\tilde{T}_j = 0$ to 125° C (AN79L10) and $T_j = 0$ to 100° C (AN79L10M)

• AN79L12, AN79L12M (-12V type)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Output voltage	Vo	$T_j = 25^{\circ}C$	-11.5	-12	-12.5	v
Output voltage tolerance	Vo	$V_{I} = -15$ to $-27V$, $I_{O} = 1$ to $70mA$	-11.4		-12.6	V
Line regulation	PEG	$V_{\rm I}$ = -14.5 to -30V, $T_{\rm j}$ = 25°C			200	mV
Line regulation	KEOIN	$V_{I} = -15 \text{ to } -25 \text{V}, T_{j} = 25^{\circ} \text{C}$			100	mV
Landmanulation	DEC	$I_0 = 1$ to 100mA, $T_j = 25^{\circ}C$		20	100	mV
Load regulation	REGL	$I_0 = 1$ to 40mA, $T_j = 25^{\circ}C$		10	50	mV
Bias current	I _{Bias}	$T_j = 25^{\circ}C$		3	5	mA
Bias current fluctuation to input	$\Delta I_{Bias(IN)}$	$V_{I} = -15$ to $-27V$, $T_{j} = 25^{\circ}C$			0.5	mA
Bias current fluctuation to load	$\Delta I_{Bias(L)}$	$I_0 = 1 \text{ to } 40 \text{mA}, T_j = 25^{\circ}\text{C}$			0.1	mA
Output noise voltage	V _{no}	$f = 10Hz$ to 100kHz, $T_a = 25^{\circ}C$		75		μν
Ripple rejection ratio	RR	$V_{I} = -15$ to $-25V$, $f = 120Hz$, $T_{a} = 25^{\circ}C$	52			dB
Minimum input/output voltage difference	V _{DIF(min)}	$T_j = 25^{\circ}C$		0.8		V
Output short-circuit current	I _{O(Short)}	$V_I = -35V, T_j = 25^{\circ}C$		200		mA
Output voltage temperature coefficient	$\Delta V_0/T_a$	$I_0 = 5mA$		- 0.8		mV/°C

Note 1) The specified condition $T_j = 25^{\circ}C$ means that the test should be carried out within so short a test time (within 10ms) that the characteristic value drift due to the chip junction temperature rise can be ignored.

Note 2) Unless otherwise specified, $V_I = -19V$, $I_0 = 40$ mA, $C_I = 2\mu$ F, $C_0 = 1\mu$ F, $T_j = 0$ to 125° C (AN79L12) and $T_j = 0$ to 100° C (AN79L12M)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Output voltage	Vo	$T_j = 25^{\circ}C$	-14.4	-15	-15.6	V
Output voltage tolerance	Vo	$V_{I} = -18$ to $-28V$, $I_{O} = 1$ to $70mA$	-14.25		-15.75	V
Line regulation	DEC	$V_{I} = -17.5$ to $-33V$, $T_{j} = 25^{\circ}C$			200	mV
Line regulation	KEOIN	$V_{I} = -18$ to $-28V$, $T_{j} = 25^{\circ}C$			100	mV
Lood monulation	DEC	$I_0 = 1$ to 100mA, $T_j = 25^{\circ}C$		25	130	mV
Load regulation	REGL	$I_0 = 1 \text{ to } 40 \text{mA}, T_j = 25^{\circ}\text{C}$	_	12	60	mV
Bias current	I _{Bias}	$T_j = 25^{\circ}C$		3	5	mA
Bias current fluctuation to input	$\Delta I_{Bias(IN)}$	$V_{I} = -18$ to $-30V$, $T_{j} = 25^{\circ}C$			0.5	mA
Bias current fluctuation to load	$\Delta I_{Bias(L)}$	$I_0 = 1 \text{ to } 40 \text{mA}, T_j = 25^{\circ}\text{C}$			0.1	mA
Output noise voltage	V _{no}	$f = 10Hz$ to 100kHz, $T_a = 25^{\circ}C$		90		μV
Ripple rejection ratio	RR	$V_{I} = -18$ to $-28V$, $f = 120Hz$, $T_{a} = 25^{\circ}C$	51			dB
Minimum input/output voltage difference	V _{DIF(min)}	$T_j = 25^{\circ}C$		0.8		V
Output short-circuit current	I _{O(Short)}	$V_I = -35V, T_j = 25^{\circ}C$		200		mA
Output voltage temperature coefficient	$\Delta V_0/T_a$	$I_0 = 5mA$		- 0.9		mV/°C

• AN79L15, AN79L15M (-15V type)

Note 1) The specified condition $T_j = 25^{\circ}C$ means that the test should be carried out within so short a test time (within 10ms) that the characteristic value drift due to the chip junction temperature rise can be ignored.

Note 2) Unless otherwise specified, $V_I = -23V$, $I_0 = 40$ mA, $C_I = 2\mu$ F, $C_0 = 1\mu$ F, $T_j = 0$ to 125° C (AN79L15) and $T_j = 0$ to 100° C (AN79L15M)

• AN79L18 (-18V type)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Output voltage	Vo	$T_j = 25^{\circ}C$	-17.3	-18	-18.7	V
Output voltage tolerance	Vo	$V_{I} = -21$ to $-33V$, $I_{O} = 1$ to $70mA$	-17.1		-18.9	V
Line regulation	PEC	$V_{I} = -21$ to $-33V$, $T_{j} = 25^{\circ}C$			200	mV
Line regulation	KEOIN	$V_{I} = -21$ to $-32V$, $T_{j} = 25^{\circ}C$			100	mV
Load regulation	DEC	$I_0 = 1$ to 100mA, $T_j = 25^{\circ}C$		30	160	mV
	REGL	$I_0 = 1 \text{ to } 40 \text{mA}, T_j = 25^{\circ}\text{C}$		15	80	mV
Bias current	I _{Bias}	$T_j = 25^{\circ}C$		3	5	mA
Bias current fluctuation to input	$\Delta I_{Bias(IN)}$	$V_{I} = -21$ to $-33V$, $T_{j} = 25^{\circ}C$			0.5	mA
Bias current fluctuation to load	$\Delta I_{Bias(L)}$	$I_0 = 1 \text{ to } 40 \text{mA}, T_j = 25^{\circ}\text{C}$			0.1	mA
Output noise voltage	V _{no}	$f = 10Hz$ to 100kHz, $T_a = 25^{\circ}C$		110		μν
Ripple rejection ratio	RR	$V_{I} = -22$ to $-32V$, f = 120Hz, $T_{a} = 25^{\circ}C$	50			dB
Minimum input/output voltage difference	V _{DIF(min)}	$T_j = 25^{\circ}C$		0.8		v
Output short-circuit current	I _{O(Short)}	$V_{I} = -35V, T_{j} = 25^{\circ}C$		200		mA
Output voltage temperature coefficient	$\Delta V_0/T_a$	$I_0 = 5mA$		-1		mV/°C

Note 1) The specified condition $T_j = 25^{\circ}C$ means that the test should be carried out within so short a test time (within 10ms) that the characteristic value drift due to the chip junction temperature rise can be ignored.

Note 2) Unless otherwise specified, $V_I = -27V$, $I_O = 40mA$, $C_I = 2\mu F$, $C_O = 1\mu F$, $T_j = 0$ to $125^{\circ}C$

• AN79L20 (-20V type)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Output voltage	Vo	$T_j = 25^{\circ}C$	-19.2	-20	-20.8	V
Output voltage tolerance	Vo	$V_{I} = -23$ to $-35V$, $I_{O} = 1$ to $70mA$	-19		-21	v
Line regulation	DEC	$V_I = -23$ to $-35V$, $T_j = 25^{\circ}C$	_		200	mV
	KLOIN	$V_{I} = -24$ to $-34V$, $T_{j} = 25^{\circ}C$	_		100	mV
Load regulation	DEC	$I_0 = 1$ to 100mA, $T_j = 25^{\circ}C$		35	180	mV
Load regulation	KEGL	$I_0 = 1$ to 40mA, $T_j = 25^{\circ}C$		17	90	mV
Bias current	I _{Bias}	$T_j = 25^{\circ}C$		3	5	mA
Bias current fluctuation to input	$\Delta I_{Bias(IN)}$	$V_I = -23$ to $-35V$, $T_j = 25^{\circ}C$	_	—	0.5	mA
Bias current fluctuation to load	$\Delta I_{Bias(L)}$	$I_0 = 1$ to 40mA, $T_j = 25^{\circ}C$	_		0.1	mA
Output noise voltage	V _{no}	$f = 10Hz$ to 100kHz, $T_a = 25^{\circ}C$		135		μν
Ripple rejection ratio	RR	$V_{I} = -24$ to $-34V$, f = 120Hz, $T_{a} = 25^{\circ}C$	49			dB
Minimum input/output voltage difference	V _{DIF(min)}	$T_j = 25^{\circ}C$		0.8		V
Output short-circuit current	I _{O(Short)}	$V_I = -35V, T_j = 25^{\circ}C$		200		mA
Output voltage temperature coefficient	$\Delta V_0/T_a$	$I_0 = 5mA$		-1		mV/°C

Note 1) The specified condition $T_j = 25^{\circ}C$ means that the test should be carried out within so short a test time (within 10ms) that the characteristic value drift due to the chip junction temperature rise can be ignored.

Note 2) Unless otherwise specified, $V_1 = -29V$, $I_0 = 40mA$, $C_1 = 2\mu F$, $C_0 = 1\mu F$, $T_j = 0$ to $125^{\circ}C$

• AN79L24 (-24V type)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Output voltage	Vo	$T_j = 25^{\circ}C$	-23	-24	-25	V
Output voltage tolerance	Vo	$V_{I} = -27$ to $-38V$, $I_{O} = 1$ to $70mA$	-22.8		-25.2	V
Line regulation	REG _{IN}	$V_I = -27$ to $-38V$, $T_j = 25^{\circ}C$			200	mV
		$V_{I} = -27 \text{ to } -37 \text{V}, T_{j} = 25^{\circ} \text{C}$			100	mV
Load regulation	REGL	$I_0 = 1$ to 100mA, $T_j = 25^{\circ}C$		40	200	mV
		$I_0 = 1 \text{ to } 40 \text{mA}, T_j = 25^{\circ}\text{C}$		20	100	mV
Bias current	I _{Bias}	$T_j = 25^{\circ}C$		3	5	mA
Bias current fluctuation to input	$\Delta I_{Bias(IN)}$	$V_{I} = -27$ to $-38V$, $T_{j} = 25^{\circ}C$			0.5	mA
Bias current fluctuation to load	$\Delta I_{Bias(L)}$	$I_0 = 1 \text{ to } 40 \text{mA}, T_j = 25^{\circ}\text{C}$			0.1	mA
Output noise voltage	V _{no}	$f = 10Hz$ to 100kHz, $T_a = 25^{\circ}C$		170		μν
Ripple rejection ratio	RR	$V_I = -28$ to $-38V$, f = 120Hz, $T_a = 25^{\circ}C$	49			dB
Minimum input/output voltage difference	V _{DIF(min)}	$T_j = 25^{\circ}C$		0.8		v
Output short-circuit current	I _{O(Short)}	$V_{I} = -35V, T_{j} = 25^{\circ}C$		200		mA
Output voltage temperature coefficient	$\Delta V_0/T_a$	$I_0 = 5mA$		-1		mV/°C

Note 1) The specified condition $T_j = 25^{\circ}C$ means that the test should be carried out within so short a test time (within 10ms) that the characteristic value drift due to the chip junction temperature rise can be ignored.

Note 2) Unless otherwise specified, $V_I = -33V$, $I_O = 40mA$, $C_I = 2\mu F$, $C_O = 1\mu F$, $T_j = 0$ to $125^{\circ}C$

Main Characteristics



Main Characteristics (continued)



Basic Regulator Circuit

100

1k

Frequency f (Hz)

10k

100k

0 L 10



Connect C_I of $2\mu F$ when the input line is long. C_0 improves the transient response. $1\mu F$

Usage Notes

1. Cautions for a basic circuit



- C_I : When a wiring from a smoothing circuit to a three-pin regulator is long, it is likely to oscillate at output. A capacitor of $0.1\mu F$ to $0.47\mu F$ should be connected near an input pin.
- C_0 : Deadly needed to prevent from oscillation (0.33µF to 1.0µF). It is recommended to use a capacitor of a small internal impedance (ex. tantalum capacitor) when using it under a low temperature.

When any sudden change of load current is likely to occur, connect an electrolytic capacitor of 10μ F to 100μ F to improve a transitional response of output voltage.

D_i: Normally unnecessary. But add it in the case that there is a residual voltage at the output capacitor Co even after switching off the supply power because a current is likely to flow into an output pin of the IC and damage the IC.

2. Other caution items

1) Short-circuit between the input pin and GND pin

If the input pin is short-circuitted to GND or is cut off when a large capacitance capacitor has been connected to the IC's load, a voltage of a capacitor connected to an output pin is applied between input/output of the IC and this likely results in damage of the IC. It is necessary, therefore, to connect a diode, as shown in figure 2, to counter the reverse bias between input/output pins.



2) Floating of GND pin

If a GND pin is made floating in an operating mode, an unstabilized input voltage is outputted. In this case, a thermal protection circuit inside the IC does not normally operate. In this state, if the load is short-circuited or overloaded, it is likely to damage the IC.

Application Circuit Example





- New Package Dimensions (Unit: mm)
- SSIP003-P-0000S (Lead-free package)



• HSIP003-P-0000Q (Lead-free package)



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